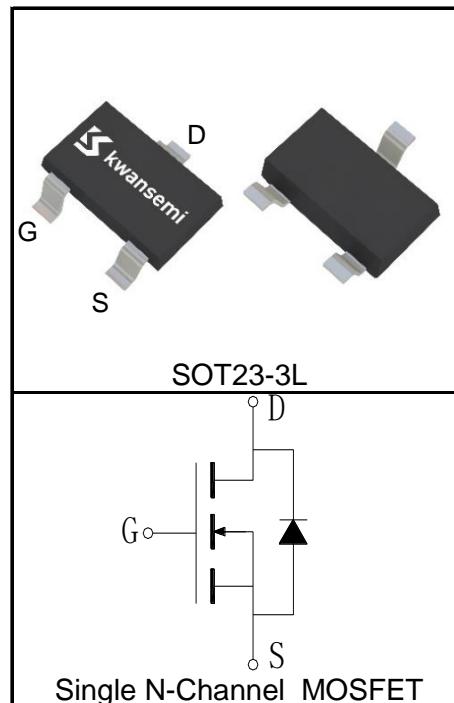


## Features

- 20V/6A,  
 $R_{DS(ON)} = 17m\Omega$ (Typ.)@ $V_{GS}=4.5V$
- $R_{DS(ON)} = 20m\Omega$ (Typ.)@ $V_{GS}=2.5V$
- Low  $R_{DS(ON)}$
- Super High Dense Cell Design
- Reliable and Rugged

## Pin Description



## Applications

- Load Switch



Halogen-Free

## Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
<b>Common Ratings</b> ( $T_A=25^\circ C$ Unless Otherwise Noted)			
$V_{DSS}$	Drain-Source Voltage	20	V
$V_{GSS}$	Gate-Source Voltage	$\pm 12$	
$T_{Jmax}$	Maximum Junction Temperature	150	$^\circ C$
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to 150	$^\circ C$
$I_S$	Diode Continuous Forward Current	$T_A=25^\circ C$	1.6
<b>Mounted on Large Heat Sink</b>			
$I_{DP}^{①}$	Pulse Drain Current	$T_A=25^\circ C$	24
$I_D^{②}$	Continuous Drain Current( $V_{GS}=4.5V$ )	$T_A=25^\circ C$	6
		$T_A=70^\circ C$	4.8
$P_D$	Maximum Power Dissipation	$T_A=25^\circ C$	1.3
		$T_A=70^\circ C$	0.8
$R_{\theta JL}$	Thermal Resistance-Junction to Lead	60	$^\circ C/W$
$R_{\theta JA}^{③}$	Thermal Resistance-Junction to Ambient	100	$^\circ C/W$
<b>Drain-Source Avalanche Ratings</b>			
$E_{AS}^{④}$	Avalanche Energy, Single Pulsed	12	mJ

**Electrical Characteristics** ( $T_A=25^\circ\text{C}$  Unless Otherwise Noted)

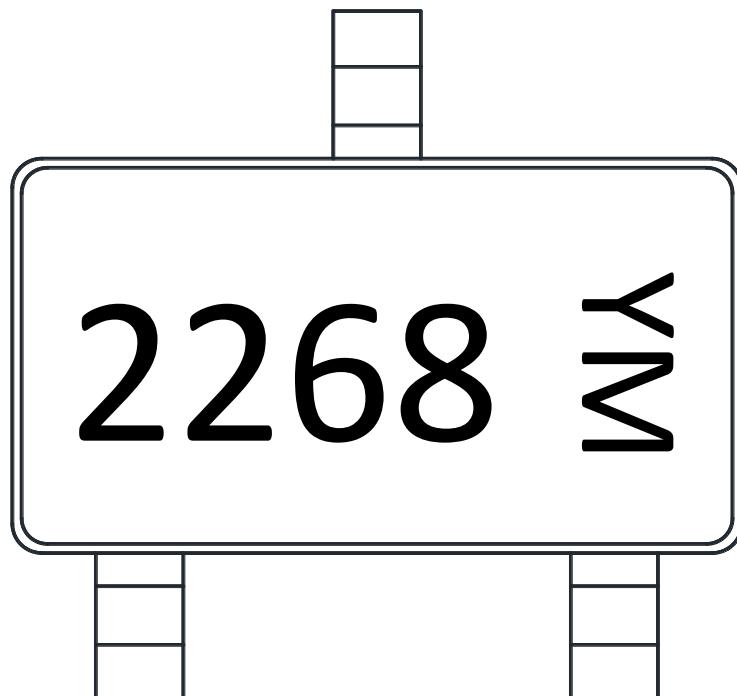
Symbol	Parameter	Test Condition	KS2268EA			Unit
			Min.	Typ.	Max.	
<b>Static Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_{\text{DS}}=250\mu\text{A}$	20			V
$\text{I}_{\text{DSS}}$	Zero Gate Voltage Drain Current	$\text{V}_{\text{DS}}=20\text{V}, \text{V}_{\text{GS}}=0\text{V}$			1	$\mu\text{A}$
		$\text{T}_J=125^\circ\text{C}$			30	
$\text{V}_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_{\text{DS}}=250\mu\text{A}$	0.5	0.7	1.1	V
$\text{I}_{\text{GSS}}$	Gate Leakage Current	$\text{V}_{\text{GS}}=\pm 12\text{V}, \text{V}_{\text{DS}}=0\text{V}$			$\pm 100$	nA
$\text{R}_{\text{DS}(\text{ON})}^{(5)}$	Drain-Source On-state Resistance	$\text{V}_{\text{GS}}=4.5\text{V}, \text{I}_{\text{DS}}=3\text{A}$		17	22	m $\Omega$
		$\text{V}_{\text{GS}}=2.5\text{V}, \text{I}_{\text{DS}}=2\text{A}$		20	28	m $\Omega$
<b>Diode Characteristics</b>						
$\text{V}_{\text{SD}}^{(5)}$	Diode Forward Voltage	$\text{I}_{\text{SD}}=3\text{A}, \text{V}_{\text{GS}}=0\text{V}$		0.8	1.2	V
$\text{t}_{\text{rr}}$	Reverse Recovery Time	$\text{I}_{\text{SD}}=3\text{A}, \frac{d\text{I}_{\text{SD}}}{dt}=100\text{A}/\mu\text{s}$		12		ns
$\text{Q}_{\text{rr}}$	Reverse Recovery Charge			28		nC
<b>Dynamic Characteristics</b> <sup>(6)</sup>						
$\text{R}_G$	Gate Resistance	$\text{V}_{\text{GS}}=0\text{V}, \text{V}_{\text{DS}}=0\text{V}, \text{F}=1\text{MHz}$		6		$\Omega$
$\text{C}_{\text{iss}}$	Input Capacitance	$\text{V}_{\text{GS}}=0\text{V}, \text{V}_{\text{DS}}=10\text{V}, \text{Frequency}=1.0\text{MHz}$		550		$\text{pF}$
$\text{C}_{\text{oss}}$	Output Capacitance			90		
$\text{C}_{\text{rss}}$	Reverse Transfer Capacitance			70		
$\text{t}_{\text{d}(\text{ON})}$	Turn-on Delay Time	$\text{V}_{\text{DD}}=10\text{V}, \text{I}_{\text{DS}}=3\text{A}, \text{V}_{\text{GEN}}=4.5\text{V}, \text{R}_G=6\Omega$		10		ns
$\text{t}_{\text{r}}$	Turn-on Rise Time			24		
$\text{t}_{\text{d}(\text{OFF})}$	Turn-off Delay Time			43		
$\text{t}_{\text{f}}$	Turn-off Fall Time			16		
<b>Gate Charge Characteristics</b> <sup>(6)</sup>						
$\text{Q}_g$	Total Gate Charge	$\text{V}_{\text{DS}}=10\text{V}, \text{V}_{\text{GS}}=4.5\text{V}, \text{I}_{\text{DS}}=3\text{A}$		7.3		nC
$\text{Q}_{\text{gs}}$	Gate-Source Charge			0.8		
$\text{Q}_{\text{gd}}$	Gate-Drain Charge			2		

Notes:

- (1)Pulse width limited by safe operating area.
- (2)Calculated continuous current based on maximum allowable junction temperature.
- (3)When mounted on 1 inch square copper board,  $t \leq 10\text{sec}$ . The value in any given application depends on the user's specific board design.
- (4)Limited by  $T_{J\max}$ , Starting  $T_J = 25^\circ\text{C}$ ,  $I_{AS\max} = 7\text{A}$ ,  $L=0.5\text{mH}$ ,  $V_{\text{DD}} = 12\text{V}$ ,  $R_G = 25\Omega$ ,  $V_{\text{GS}}=4.5\text{V}$ .Part not recommended for use above this value.
- (5)Pulse test; Pulse width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .
- (6)Guaranteed by design, not subject to production testing.

**Ordering and Marking Information**

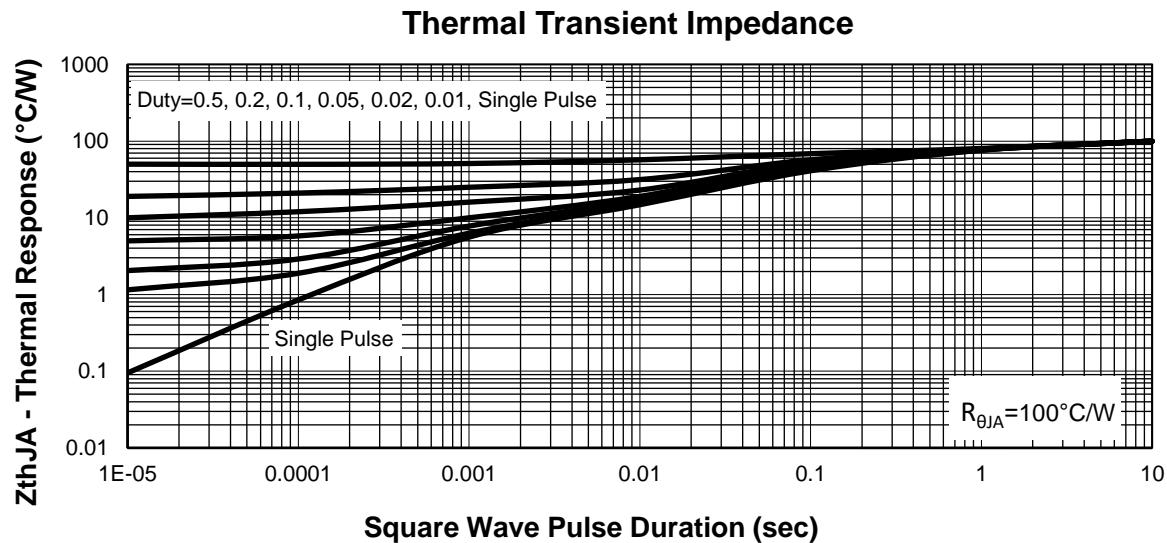
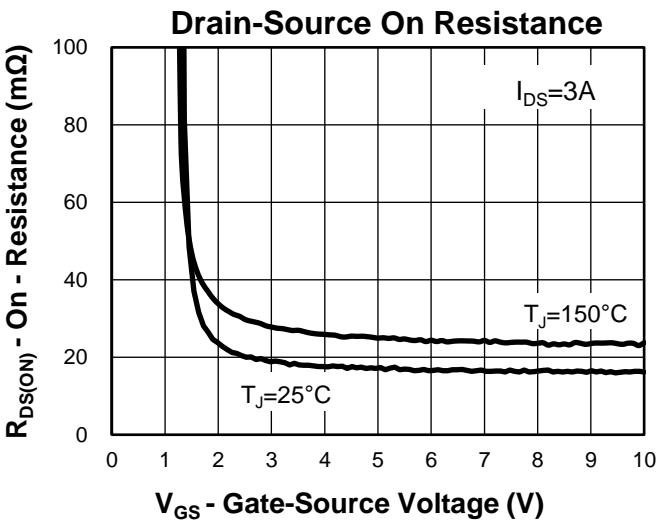
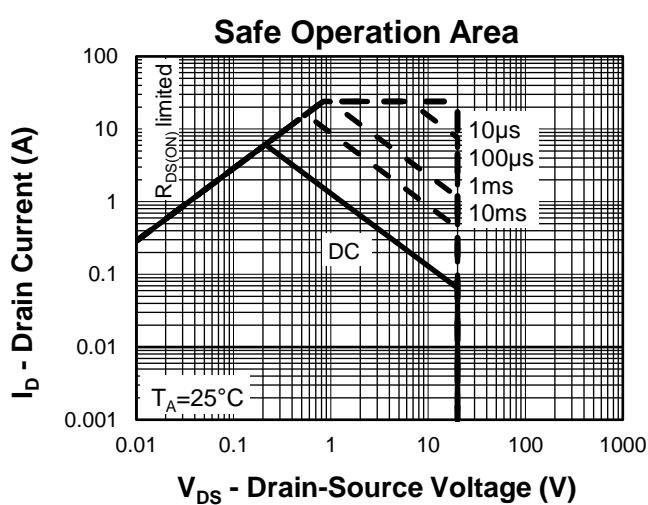
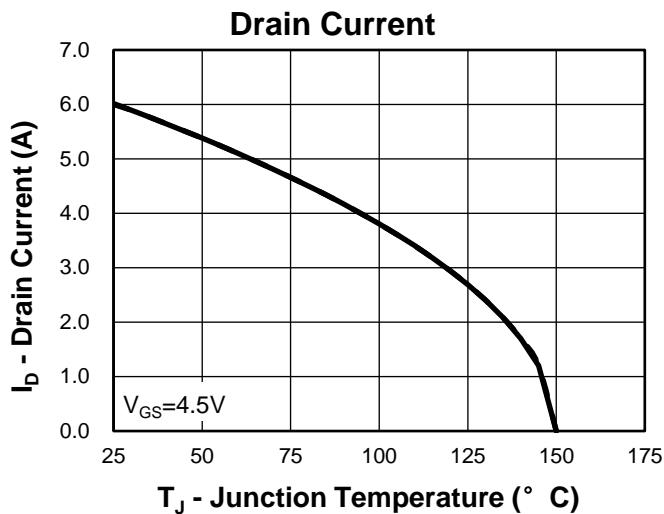
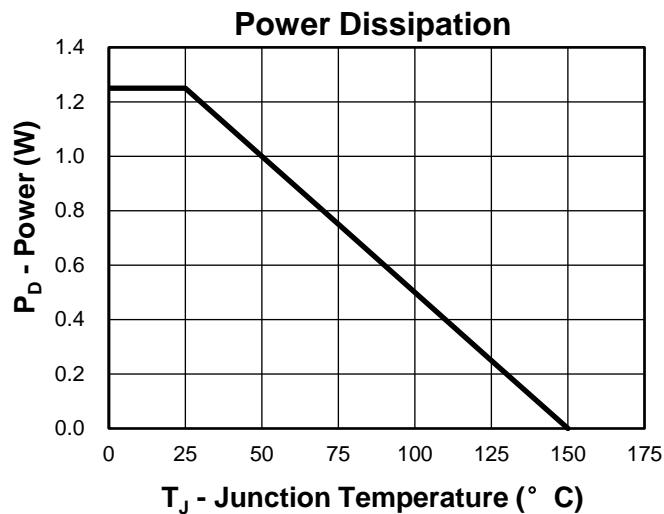
Device	Package	Packaging	Quantity	Reel Size	Tape width
KS2268EA	SOT23-3L	Tape&Reel	3000	7"	8mm



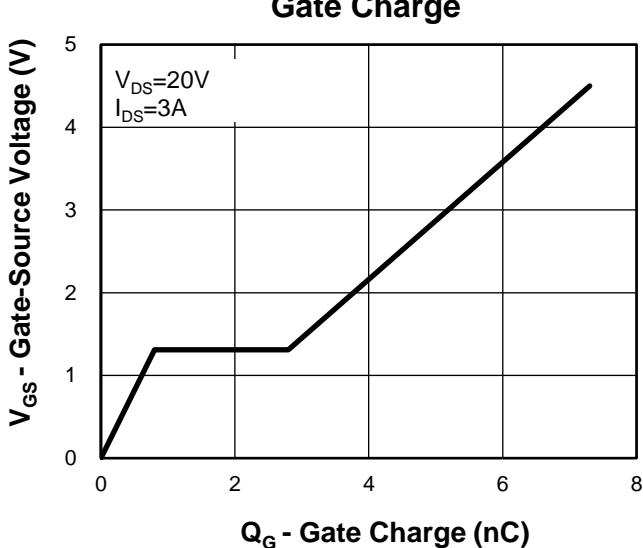
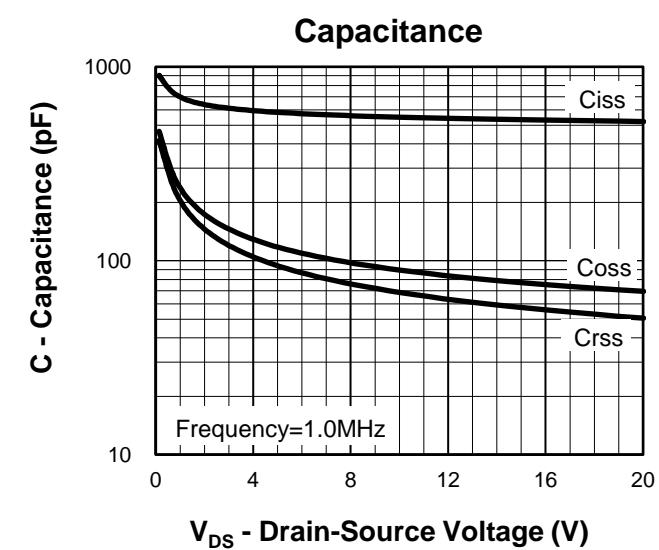
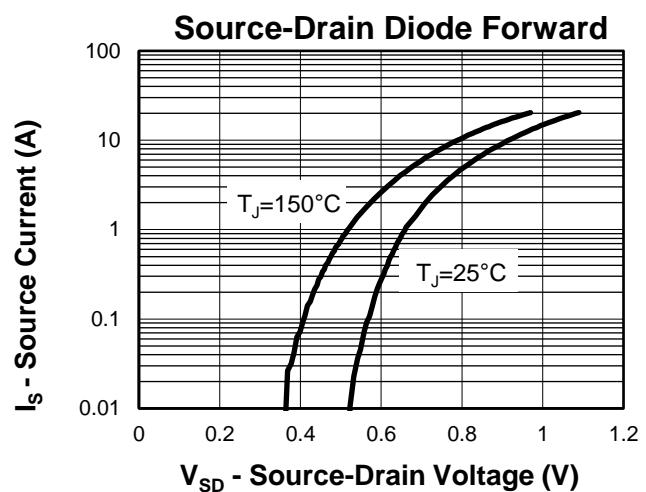
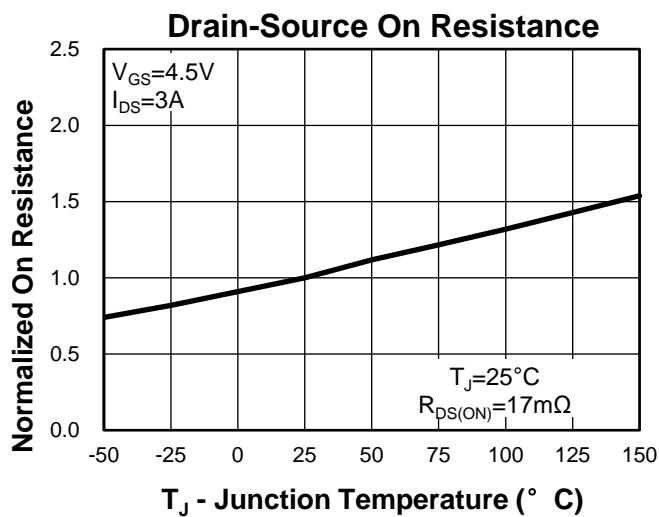
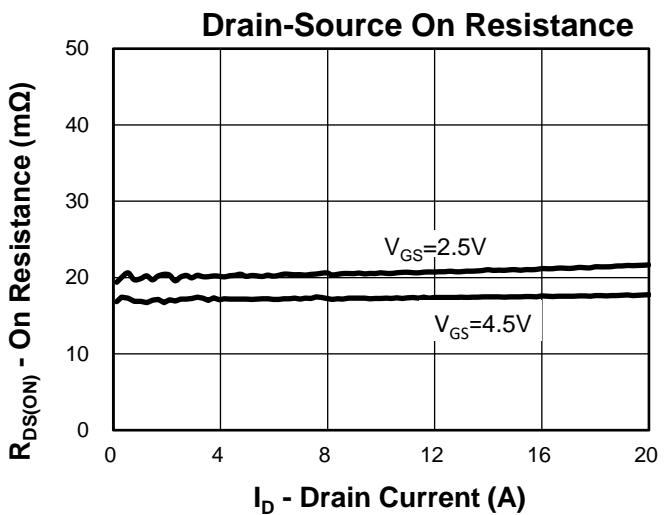
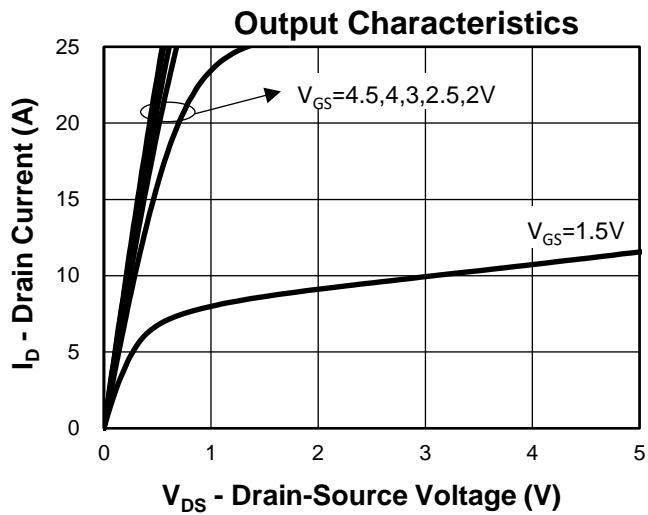
Y =Year,2017-A,2018-B,etc.

M =Month,Jan-1,Feb-2,...,Sep-9,Oct-A,Nov-B,Dec-C.

## Typical Characteristics

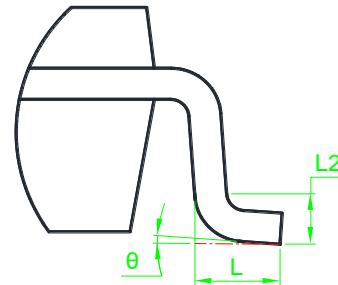
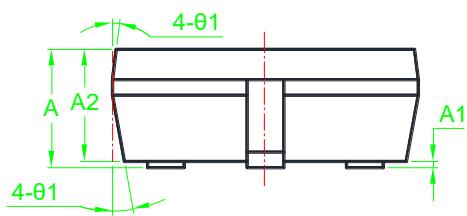
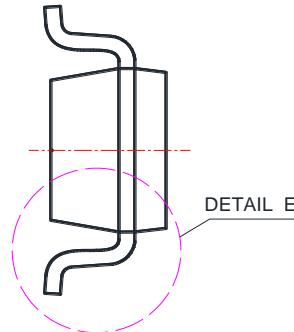
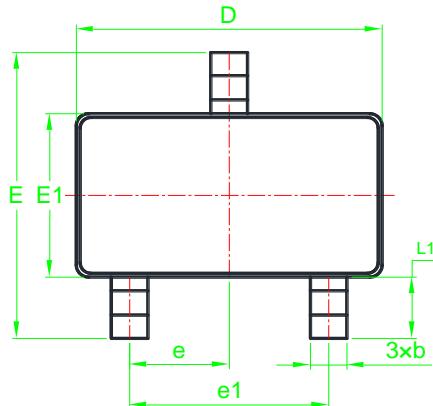


## Typical Characteristics



## Package Information

### SOT23-3L

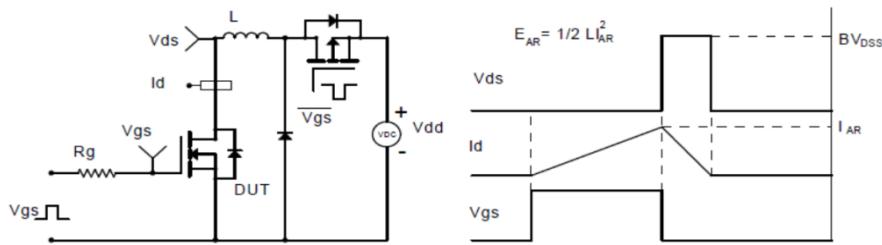


DETAIL E

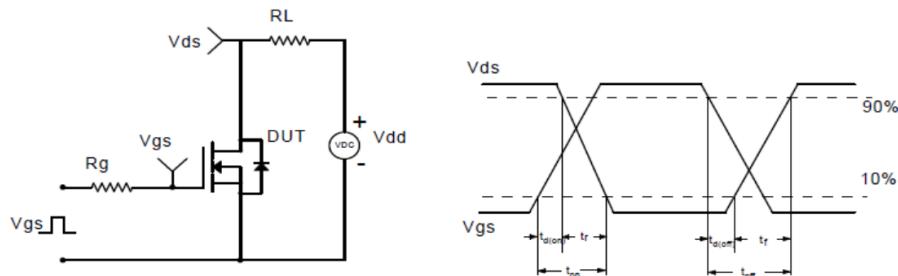
SYMBOL	MM			INCH			SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX		MIN	NOM	MAX	MIN	NOM	MAX
A	1.05	1.15	1.25	0.041	0.045	0.049	e	0.95BSC			0.037BSC		
A1	0.01	*	0.10	0.000	*	0.004	e1	1.9BSC			0.075BSC		
A2	1.05	1.10	1.15	0.041	0.043	0.045	L	0.30	0.45	0.60	0.012	0.018	0.024
b	0.30	0.40	0.50	0.012	0.016	0.020	L1	0.6REF			0.024REF		
D	2.82	2.92	3.02	0.111	0.115	0.119	L2	0.254BSC			0.01BSC		
E	2.65	2.80	2.95	0.104	0.110	0.116	θ	0°	*	8°	0°	*	8°
E1	1.50	1.60	1.70	0.059	0.063	0.067	θ1	0°	*	10°	0°	*	10°

Note: Dimensions do not include burrs and mold flash.

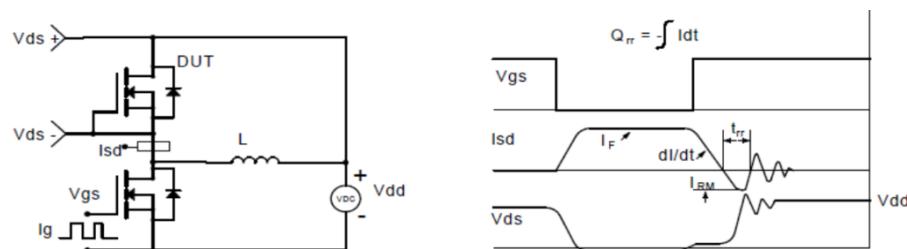
### Avalanche Test Circuit and Waveforms



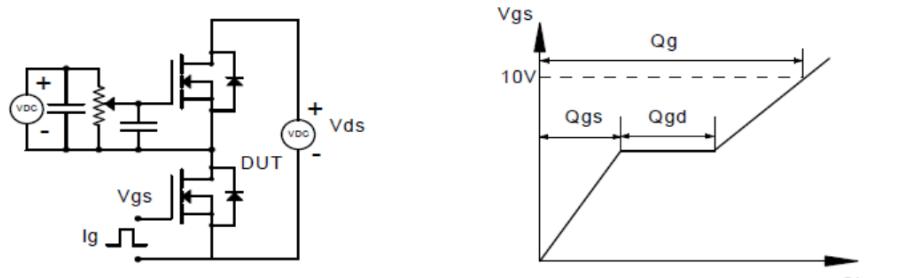
### Switching Time Test Circuit and Waveforms



### Diode Recovery Test Circuit and Waveforms



### Gate Charge Test Circuit and Waveform



### Customer Service

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Web:[www.kwansemi.com](http://www.kwansemi.com)

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